

74LVT244A; 74LVTH244A

3.3 V octal buffer/line driver; 3-state

Rev. 04 — 3 September 2008

Product data sheet

1. General description

The 74LVT244A; 74LVTH244A is a high-performance BiCMOS product designed for V_{CC} operation at 3.3 V.

This device is an octal buffer that is ideal for driving bus lines. The device features two output enables ($\overline{1OE}$, $\overline{2OE}$), each controlling four of the 3-state outputs.

2. Features

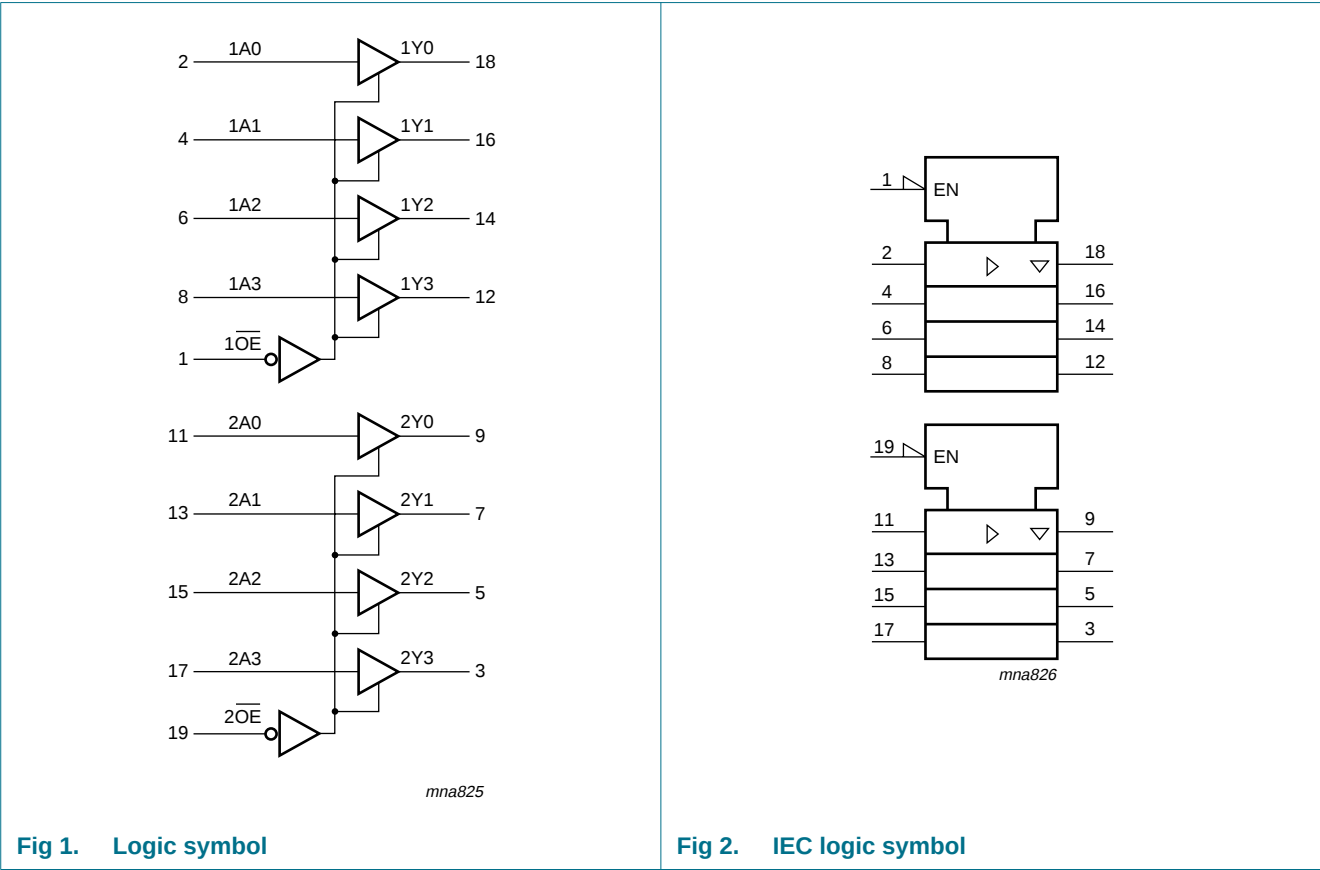
- Octal bus interface
- 3-state buffers
- Output capability: +64 mA and –32 mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5 V supply
- Bus hold data inputs eliminate need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- Power-up 3-state
- No bus current loading when output is tied to 5 V bus
- Latch-up protection
 - ◆ JESD78 Class II exceeds 500 mA
- ESD protection:
 - ◆ HBM JESD22-A114E exceeds 2000 V
 - ◆ MM JESD22-A115-A exceeds 200 V

3. Ordering information

Table 1. Ordering information

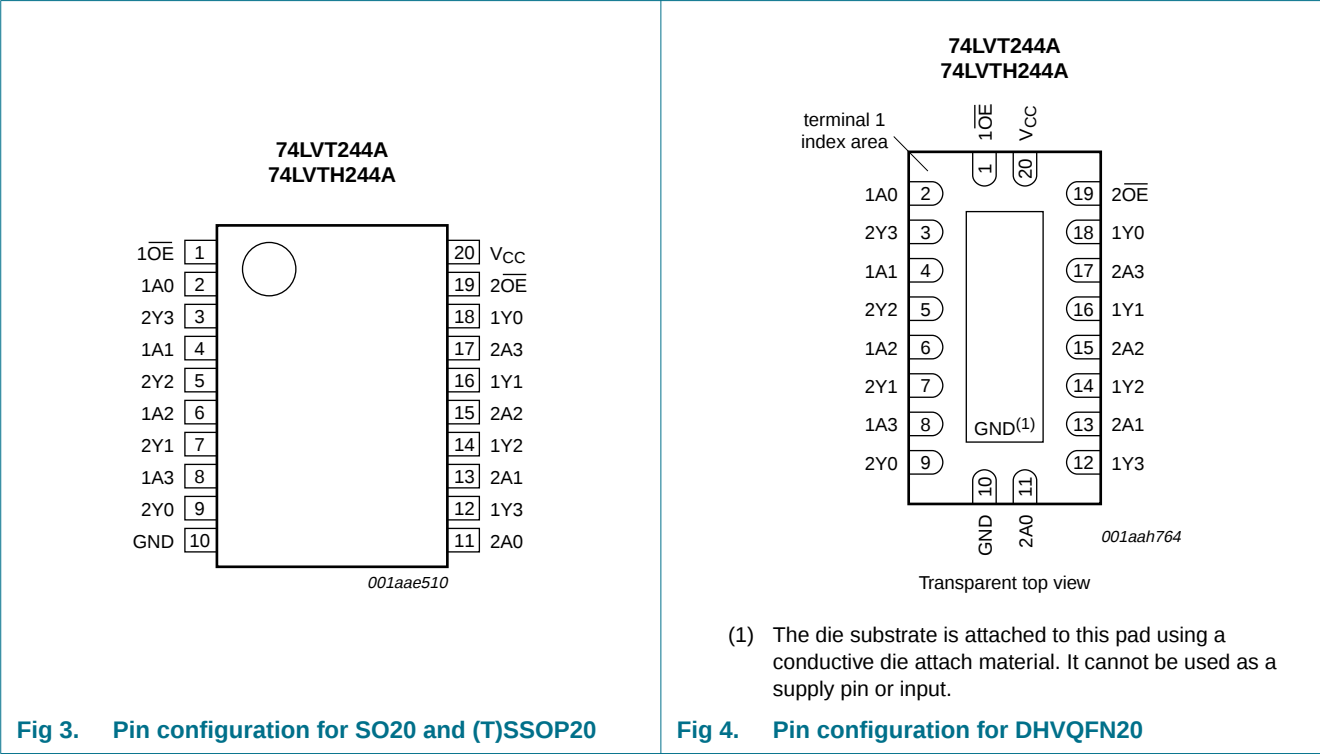
Type number	Package			
	Temperature range	Name	Description	Version
74LVT244AD 74LVTH244AD	–40 °C to +85 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74LVT244ADB 74LVTH244ADB	–40 °C to +85 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1
74LVT244APW 74LVTH244APW	–40 °C to +85 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74LVT244ABQ 74LVTH244ABQ	–40 °C to +85 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm	SOT764-1

4. Functional diagram



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1OE, 2OE	1, 19	output enable input (active low)
1A0, 1A1, 1A2, 1A3	2, 4, 6, 8	data input
2Y0, 2Y1, 2Y2, 2Y3	9, 7, 5, 3	data output
GND	10	ground (0 V)
2A0, 2A1, 2A2, 2A3	11, 13, 15, 17	data input
1Y0, 1Y1, 1Y2, 1Y3	18, 16, 14, 12	data output
VCC	20	supply voltage

6. Functional description

6.1 Function table

Table 3. Function table [\[1\]](#)

Control	Input	Output
nOE	nAn	nYn
L	L	L
	H	H
H	X	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
V_I	input voltage		[1] -0.5	+7.0	V
V_O	output voltage	output in OFF-state or HIGH-state	[1] -0.5	+7.0	V
I_{IK}	input clamping current	$V_I < 0$ V	-	-50	mA
I_{OK}	output clamping current	$V_O < 0$ V	-	-50	mA
I_O	output current	output in LOW-state	-	128	mA
		output in HIGH-state	-	-64	mA
T_{stg}	storage temperature		-65	+150	°C
T_j	junction temperature		[2] -	150	°C
P_{tot}	total power dissipation	$T_{amb} = -40$ to $+85$ °C	[3]	500	mW

[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

[3] For SO20 packages: above 70 °C derate linearly with 8 mW/K.
For SSOP20 and TSSOP20 packages: above 60 °C derate linearly with 5.5 mW/K.
For DHVQFN20 packages: above 60 °C derate linearly with 4.5 mW/K.

8. Recommended operating conditions

Table 5. Operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CC}	supply voltage		2.7	-	3.6	V
V_I	input voltage		0	-	5.5	V
I_{OH}	HIGH-level output current		-	-	-32	mA

Table 5. Operating conditions ...continued

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_{OL}	LOW-level output current	none	-	-	32	mA
		current duty cycle $\leq 50\%$; $f_i \geq 1$ kHz	-	-	64	mA
T_{amb}	ambient temperature	in free-air	-40	-	+85	°C
$\Delta t/\Delta V$	input transition rise and fall rate	outputs enabled	-	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$T_{amb} = -40\text{ °C to }+85\text{ °C}$ [1]						
V_{IK}	input clamping voltage	$V_{CC} = 2.7\text{ V}$; $I_{IK} = -18\text{ mA}$	-1.2	-0.9	-	V
V_{IH}	HIGH-level input voltage		2.0	-	-	V
V_{IL}	LOW-level input voltage		-	-	0.8	V
V_{OH}	HIGH-level output voltage	$V_{CC} = 2.7\text{ V to }3.6\text{ V}$; $I_{OH} = -100\text{ }\mu\text{A}$	$V_{CC} - 0.2$	$V_{CC} - 0.1$	-	V
		$V_{CC} = 2.7\text{ V to }3.6\text{ V}$; $I_{OH} = -8\text{ mA}$	2.4	2.5	-	V
		$V_{CC} = 3.0\text{ V}$; $I_{OH} = -32\text{ mA}$	2.0	2.2	-	V
V_{OL}	LOW-level output voltage	$V_{CC} = 2.7\text{ V}$; $I_{OL} = 100\text{ }\mu\text{A}$	-	0.1	0.2	V
		$V_{CC} = 2.7\text{ V}$; $I_{OL} = 24\text{ mA}$	-	0.3	0.5	V
		$V_{CC} = 3.0\text{ V}$; $I_{OL} = 16\text{ mA}$	-	0.25	0.4	V
		$V_{CC} = 3.0\text{ V}$; $I_{OL} = 32\text{ mA}$	-	0.3	0.5	V
		$V_{CC} = 3.0\text{ V}$; $I_{OL} = 64\text{ mA}$	-	0.4	0.55	V
I_I	input leakage current	all input pins				
		$V_{CC} = 0\text{ V or }3.6\text{ V}$; $V_I = 5.5\text{ V}$	-	0.1	10	μA
		control pins				
		$V_{CC} = 3.6\text{ V}$; $V_I = V_{CC}$ or GND	-	± 0.1	± 1	μA
		data pins [2]				
		$V_{CC} = 3.6\text{ V}$; $V_I = V_{CC}$	-	0.1	1	μA
		$V_{CC} = 3.6\text{ V}$; $V_I = 0\text{ V}$	-5	-1	-	μA
I_{OFF}	power-off leakage current	$V_{CC} = 0\text{ V}$; V_I or $V_O = 0\text{ V to }4.5\text{ V}$	-	1	± 100	μA
I_{BHL}	bus hold LOW current	$V_{CC} = 3\text{ V}$; $V_I = 0.8\text{ V}$ [3]	75	150	-	μA
I_{BHH}	bus hold HIGH current	$V_{CC} = 3\text{ V}$; $V_I = 2.0\text{ V}$	-	-150	-75	μA
I_{BHLO}	bus hold LOW overdrive current	nAn input; $V_{CC} = 0\text{ V to }3.6\text{ V}$; $V_I = 3.6\text{ V}$	500	-	-	μA
I_{BHHO}	bus hold HIGH overdrive current	nAn input; $V_{CC} = 0\text{ V to }3.6\text{ V}$; $V_I = 3.6\text{ V}$	-	-	-500	μA
I_{LO}	output leakage current	nYn output in HIGH-state when $V_O > V_{CC}$; $V_O = 5.5\text{ V}$; $V_{CC} = 3.0\text{ V}$	-	60	125	μA
$I_{O(pu/pd)}$	power-up/power-down output current	$V_{CC} \leq 1.2\text{ V}$; $V_O = 0.5\text{ V to }V_{CC}$; $V_I = \text{GND or }V_{CC}$; nOE = don't care [4]	-	± 1	± 100	μA

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_{OZ}	OFF-state output current	$V_{CC} = 3.6\text{ V}$; $V_I = V_{IH}$ or V_{IL}				
		$V_O = 3.0\text{ V}$	-	1	5	μA
		$V_O = 0.5\text{ V}$	-5	-1	-	μA
I_{CC}	supply current	$V_{CC} = 3.6\text{ V}$; $V_I = \text{GND}$ or V_{CC} ; $I_O = 0\text{ A}$				
		output HIGH	-	0.13	0.19	mA
		output LOW	-	3	12	mA
		outputs disabled [5]	-	0.13	0.19	mA
ΔI_{CC}	additional supply current	per input pin; $V_{CC} = 3.0\text{ V}$ to 3.6 V ; one input at $V_{CC} - 0.6\text{ V}$ and other inputs at V_{CC} or GND [6]	-	0.1	0.2	mA
C_I	input capacitance	$V_I = 0\text{ V}$ or 3.0 V	-	4	-	pF
C_O	output capacitance	outputs disabled; $V_O = 0\text{ V}$ or 3.0 V	-	8	-	pF

[1] All typical values are at $T_{amb} = 25\text{ }^\circ\text{C}$.[2] Unused pins at V_{CC} or GND.

[3] This is the bus hold overdrive current required to force the input to the opposite logic state.

[4] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms. From $V_{CC} = 1.2\text{ V}$ to $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ a transition time of 100 μs is permitted. This parameter is valid for $T_{amb} = 25\text{ }^\circ\text{C}$ only.[5] I_{CC} is measured with outputs pulled to V_{CC} or GND.[6] This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND.

10. Dynamic characteristics

Table 7. Dynamic characteristicsVoltages are referenced to GND (ground = 0 V); for test circuit see [Figure 7](#).

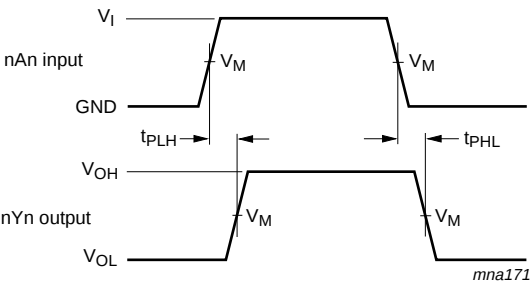
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$T_{amb} = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$ [1]						
t_{PLH}	LOW to HIGH propagation delay	nAn to nYn; see Figure 5				
		$V_{CC} = 2.7\text{ V}$	-	-	5.0	ns
		$V_{CC} = 3.0\text{ V}$ to 3.6 V	1	2.5	4.1	ns
t_{PHL}	HIGH to LOW propagation delay	nAn to nYn; see Figure 5				
		$V_{CC} = 2.7\text{ V}$	-	-	5.1	ns
		$V_{CC} = 3.0\text{ V}$ to 3.6 V	1	2.6	4.1	ns
t_{PZH}	OFF-state to HIGH propagation delay	see Figure 6				
		$V_{CC} = 2.7\text{ V}$	-	-	6.3	ns
		$V_{CC} = 3.0\text{ V}$ to 3.6 V	1	3.2	5.2	ns
t_{PZL}	OFF-state to LOW propagation delay	see Figure 6				
		$V_{CC} = 2.7\text{ V}$	-	-	6.7	ns
		$V_{CC} = 3.0\text{ V}$ to 3.6 V	1.1	3.1	5.2	ns
t_{PHZ}	HIGH to OFF-state propagation delay	see Figure 6				
		$V_{CC} = 2.7\text{ V}$	-	-	6.3	ns
		$V_{CC} = 3.0\text{ V}$ to 3.6 V	1.9	3.3	5.6	ns

Table 7. Dynamic characteristics ...continued
Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 7.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t_{PLZ}	LOW to OFF-state propagation delay	see Figure 6				
		$V_{CC} = 2.7\text{ V}$	-	-	5.6	ns
		$V_{CC} = 3.0\text{ V to } 3.6\text{ V}$	1.8	3.3	5.1	ns

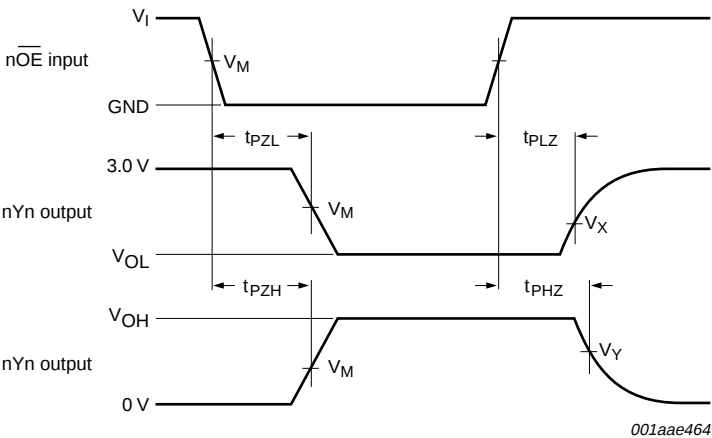
[1] All typical values are at $V_{CC} = 3.3\text{ V}$ and $T_{amb} = 25\text{ }^{\circ}\text{C}$.

11. Waveforms



Measurement points are given in Table 8.
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 5. Propagation delay input (nAn) to output (nYn) propagation delays

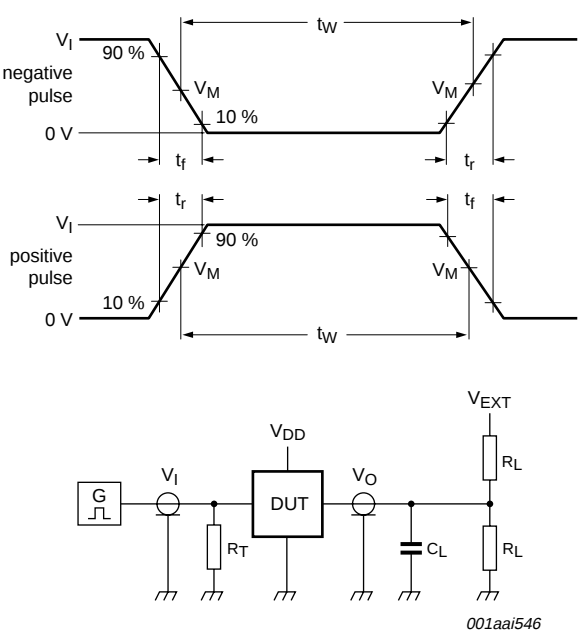


Measurement points are given in Table 8.
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 6. 3-state output enable and disable times

Table 8. Measurement points

Input	Output		
V_M	V_M	V_X	V_Y
1.5 V	1.5 V	$V_{OL} + 0.3\text{ V}$	$V_{OH} - 0.3\text{ V}$



Test data is given in [Table 9](#).
Definitions test circuit:
 R_L = Load resistance.
 C_L = Load capacitance including jig and probe capacitance.
 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.
 V_{EXT} = Test voltage for switching times.

Fig 7. Load circuitry for switching times

Table 9. Test data

Input				Load		V_{EXT}		
V_I	f_i	t_W	t_r, t_f	C_L	R_L	t_{PHZ}, t_{PZH}	t_{PLZ}, t_{PZL}	t_{PLH}, t_{PHL}
2.7 V	≤ 10 MHz	500 ns	≤ 2.5 ns	50 pF	500 Ω	GND	6 V	open

12. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1

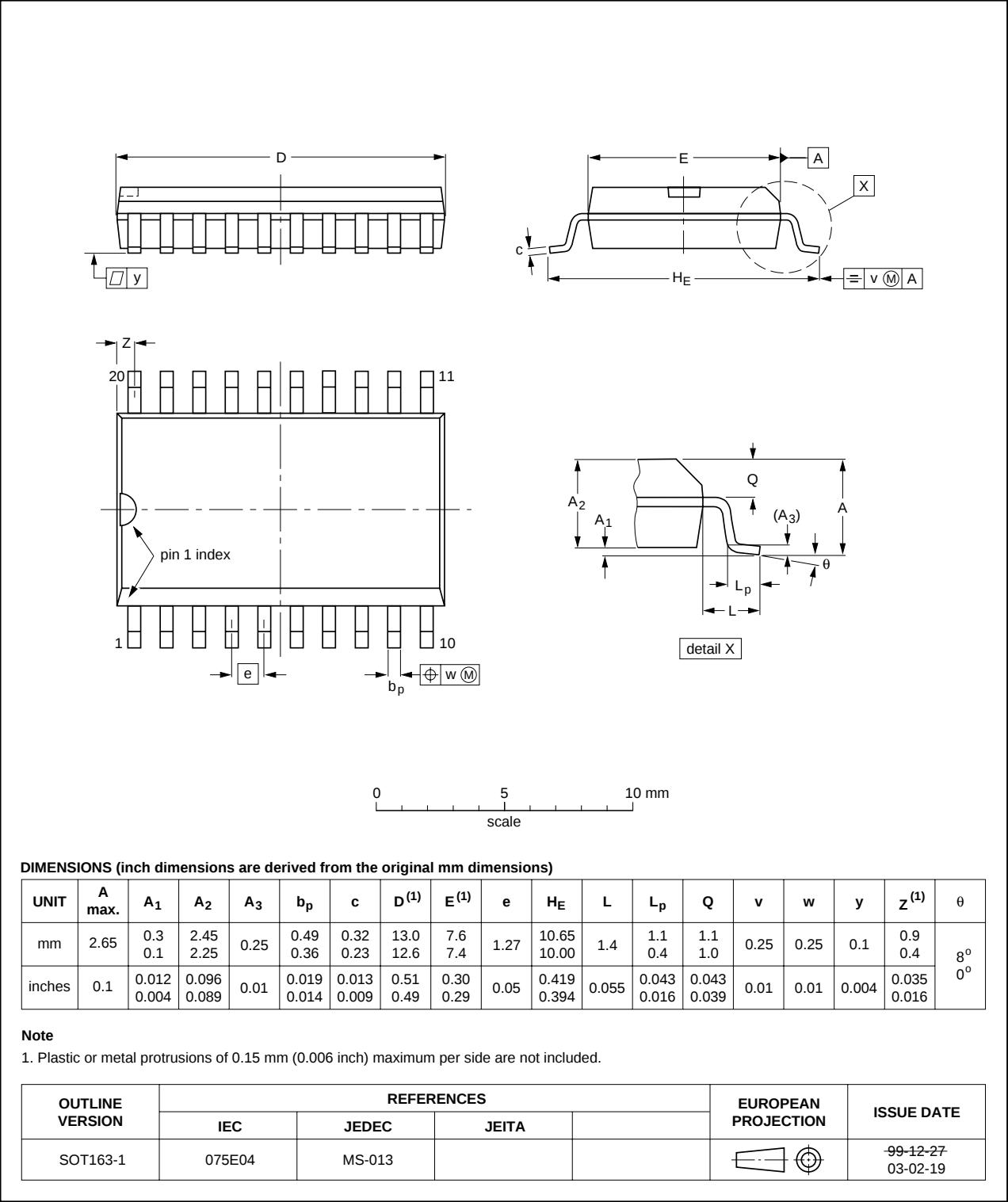


Fig 8. Package outline SOT163-1 (SO20)

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1

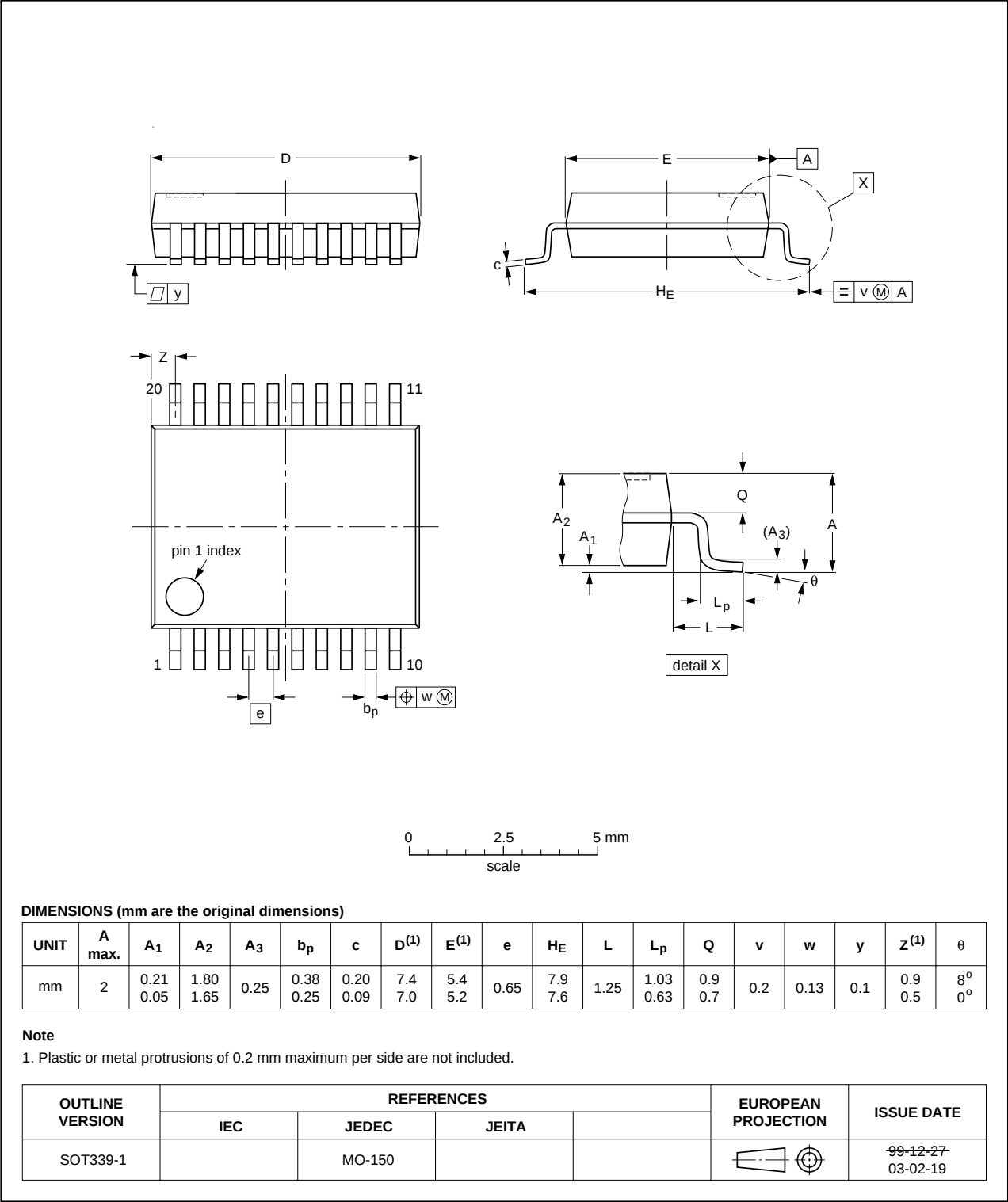


Fig 9. Package outline SOT339-1 (SSOP20)

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

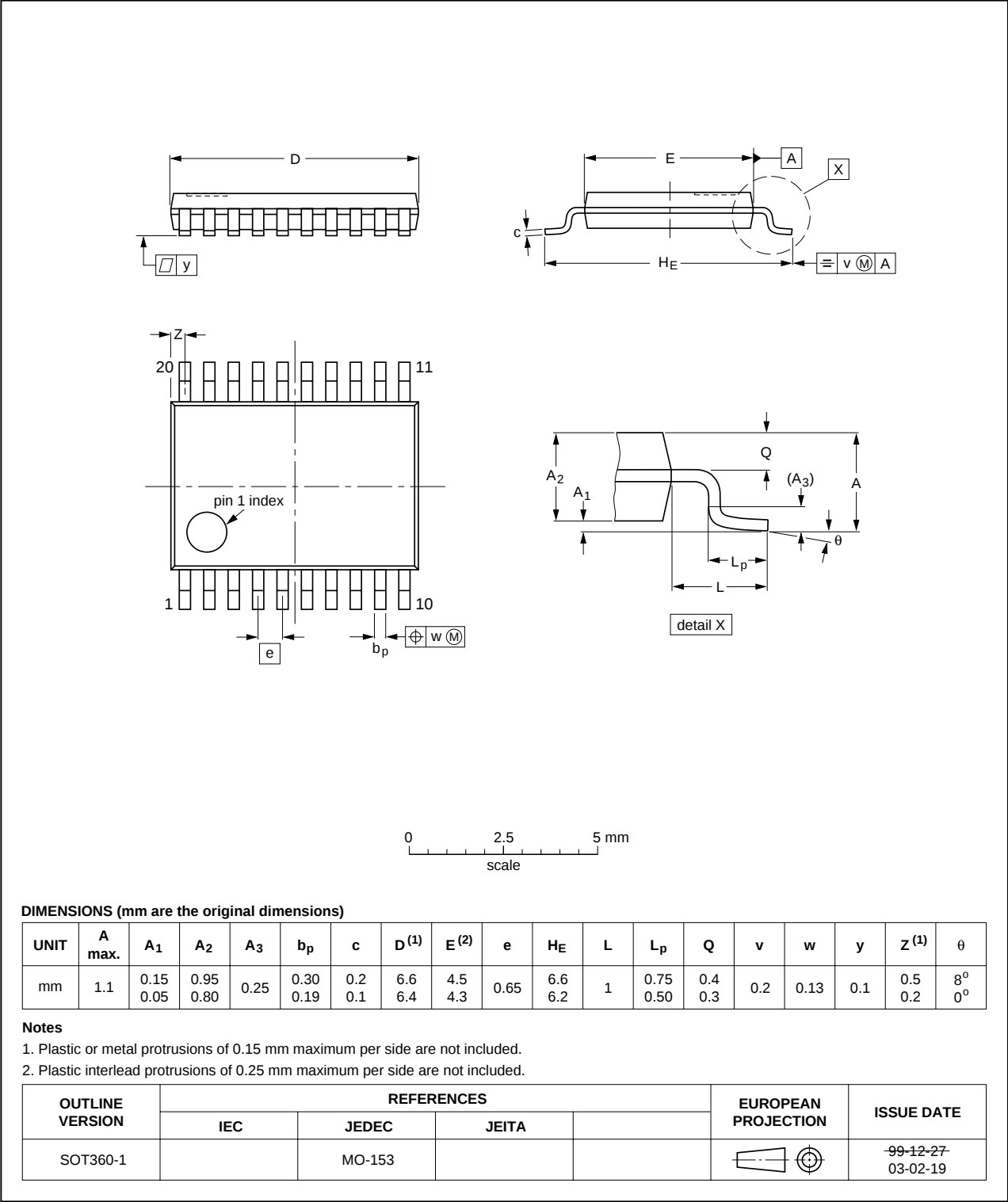


Fig 10. Package outline SOT360-1 (TSSOP20)

DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

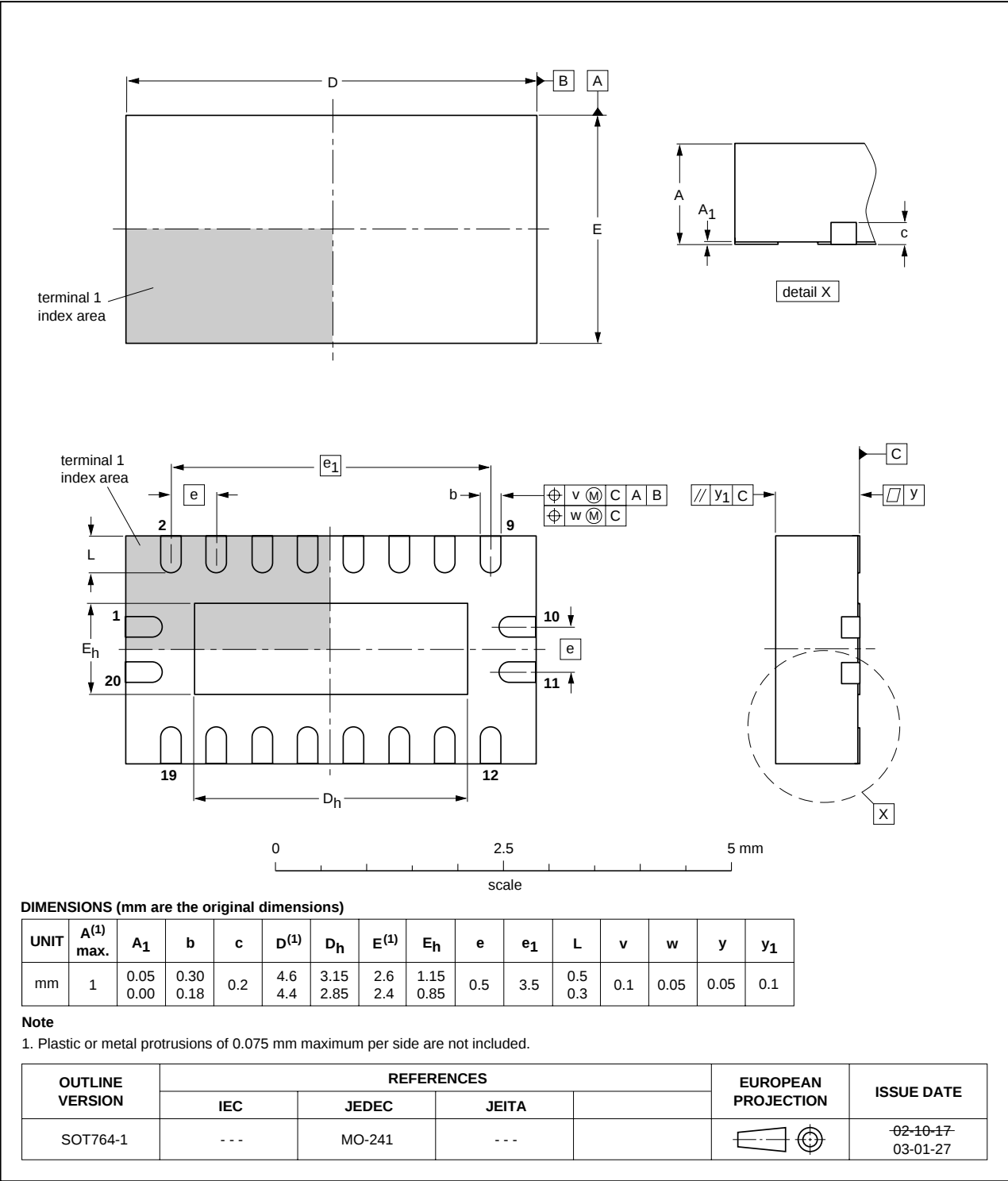


Fig 11. Package outline SOT764-1 (DHVQFN20)

13. Abbreviations

Table 10. Abbreviations

Acronym	Description
BICMOS	BiPolar Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVT_LVTH244A_4	20080903	Product data sheet	-	74LVT_LVTH244A_3
Modifications:	- The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. - Legal texts have been adapted to the new company name where appropriate. Section 3 "Ordering information" and Section 12 "Package outline" DHVQFN20 package added.			
74LVT_LVTH244A_3	20060315	Product specification	-	74LVT244A_2
74LVT244A_2	19980219	Product specification	-	74LVT244A_1

15. Legal information

15.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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